

PATENT APPLICATION
Attorney's Do. No. 7093-005
Client Ref. No. PA/NEP/04932

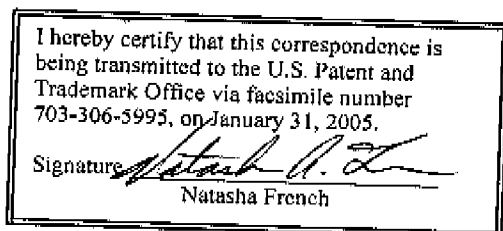
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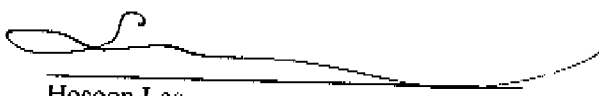
Please record the attached original document or copy thereof and return the recorded instrument to the undersigned.

1. Name of party conveying an interest: (1) Yong-Woon YEO
2. Name and address of party receiving an interest: NEPES CO., LTD.
74-10, Yongsung-Ri, Samsung-Myun,
Eumsung-Gun, Chungcheongbuk-Do, Korea
3. Description of the interest conveyed:
☒ Assignment ☐ Change of Name ☐ Security Agreement ☐ Merger ☐ Other
Date of execution of attached document: September 10, 2004
4. Application number. Additional sheet attached? Yes ___ No X
A. Patent Application No. 10/976,427 filed October 29 2004
5. Name and address of party to whom correspondence concerning document should be mailed:
MARGER JOHNSON & McCOLLOM, P.C.
1030 S.W. Morrison Street
Portland, Oregon 97205
Telephone: (503) 222-3613
6. Number of applications and patents involved: 1
7. PTO Form 2038 authorizing credit card payment (\$40) is enclosed.
8. Any deficiency or overpayment should be charged or credited to deposit account number 13-1703.
9. To the best of my knowledge and belief, the foregoing information is true and correct and an / attached copy is a true copy of the original document.

Dated: January 31, 2005



Respectfully submitted,
MARGER JOHNSON & McCOLLOM, P.C.


Hosoon Lee
Limited recognition Under 37 CFR § 10.9(b)

MARGER JOHNSON & McCOLLOM, P.C.
1030 SW Morrison Street
Portland, OR 97205
(503) 222-3613

Total number of pages comprising
cover sheet and attached assignment 3
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PATENT APPLICATION
Attorney's Do. No. 7093-005
Client Ref. No. P.VNEP/04932

ASSIGNMENT

Assignor: Yong-Woon YEO

Address: Joogong Apt. 303-1603, Joongchon-Dong, Joong-Gu, Daejeon, Korea

Assignee: NEPES CO., LTD.

Address: 74-10, Yongsung-Ri, Samsung-Myun, Eumsung-Gun,
Chungcheongbuk-Do, Korea

**Title of
Invention:** BUMP FOR SEMICONDUCTOR PACKAGE, SEMICONDUCTOR
PACKAGE APPLYING THE BUMP, AND METHOD FOR
FABRICATING THE SEMICONDUCTOR PACKAGE

U.S. Patent Application:

Application Serial No.: 10/976,427


Filing Date: October 29, 2004

For good and valuable consideration, the receipt of which is hereby acknowledged, the above-named Assignor hereby sells, assigns and transfers to Assignee, the full and exclusive right, title and interest in and to the above-identified invention, patent application and patent rights throughout the world, including foreign patent priority rights; said invention, application and letters patent in this or any foreign country, and all divisions, continuations, reissues, non-provisionals and extensions thereof, to be held and enjoyed by Assignee, for its own use and benefit, and for its successors and assigns to the full end of the term for which letters patent may be granted in this or any foreign country, as fully and entirely as the same would have been held by Assignor had this assignment and sale not been made, and covenant that Assignor has full right so to do, and agree that Assignor will communicate to Assignee, or its successors and assigns, any facts known to Assignor respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, non-

provisional and reissue applications, make all rightful oaths, and do everything possible to aid Assignee, its successors and assigns to obtain and enforce proper patent protection for said invention in this or any foreign country.

In the event that the patent application filing date or serial number is not known at the time this document is executed, Assignor hereby grants permission to the attorneys of record in the patent application to fill in the filing date and/or serial number above, and to record this assignment after such information is added.

Executed at Daejeon, Korea, this 10 day of 9, 2004.



Assignor Yong-Woon YEO